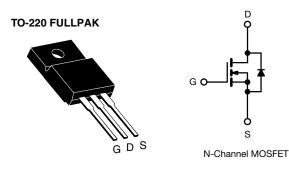
SiHF10N40D



Vishay Siliconix

D Series Power MOSFET



PRODUCT SUMMA	RY	
V_{DS} (V) at T_J max.	450)
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 V$	0.6
Q _g max. (nC)	30	
Q _{gs} (nC)	4	
Q _{gd} (nC)	7	
Configuration	Sing	le

FEATURES

- Optimal design
 - Low area specific on-resistance
 - Low input capacitance (C_{iss})
 - Reduced capacitive switching losses
 - High body diode ruggedness
 - Avalanche energy rated (UIS)
- Optimal efficiency and operation
 - Low cost
 - Simple gate drive circuitry
 - Low figure-of-merit (FOM): Ron x Qa
 - Fast switching
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

APPLICATIONS

- Consumer electronics
- Displays (LCD or plasma TV)
- Server and telecom power supplies
- SMPS
- Industrial
 - Welding
 - Induction heating
 - Motor drives
- Battery chargers

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	SiHF10N40D-E3

ABSOLUTE MAXIMUM RATINGS (T _C =	= 25 °C, unless otherwis	se noted)			
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	400		
Gate-Source Voltage		V	± 30	V	
Gate-Source Voltage AC (f > 1 Hz)		V _{GS}	30		
	$T_{\rm C} = 25 ^{\circ}{\rm C}$		10		
Continuous Drain Current ($T_J = 150 \ ^\circ C$) e	V_{GS} at 10 V $T_{C} = 100 \text{ °C}$	ID	6	A	
Pulsed Drain Current ^a		I _{DM}	23		
Linear Derating Factor			0.26	W/°C	
Single Pulse Avalanche Energy ^b		E _{AS}	194	mJ	
Maximum Power Dissipation		P _D	33	W	
Operating Junction and Storage Temperature Range	9	T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	T _J = 125 °C	24			
Reverse Diode dV/dt ^d	dV/dt	0.6	V/ns		
Soldering Recommendations (Peak temperature) ^c	For 10 s		300	°C	
Mounting Torque	M3 screw		0.6	Nm	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 2.3 mH, R_g = 25 Ω , I_{AS} = 13 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D,$ starting T_J = 25 °C.

e. Limited by maximum junction temperature.

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DADAMETER							118/27	
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-		65			°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-		3.8			0,11	
SPECIFICATIONS (T _J = 25 °C,	unless otherw	ise noted)						
PARAMETER	SYMBOL	1		IONS	MIN.	TYP.	MAX.	UNIT
Static					1			L
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D =	250 µA	400	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C,	_D = 250 μA	-	0.53	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D =	250 µA	3	-	5	V
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30$		-	-	± 100	nA
	_	V _{DS} =	400 V, V _G	_{iS} = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 320 V	′, V _{GS} = 0 \	/, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$		I _D = 5 A	-	0.5	0.6	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 50 V, I _D	= 5 A	-	2.7	-	S
Dynamic						•		
Input Capacitance	C _{iss}	$V_{GS} = 0 V, V_{DS} = 100 V, f = 1 MHz$		-	526	-	-	
Output Capacitance	C _{oss}			-	59	-		
Reverse Transfer Capacitance	C _{rss}			-	9	-		
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V _{GS} = 0 V,		-	66	-	pF	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	V _D s	s = 0 V to 3	320 V	-	84	-	
Total Gate Charge	Qq				-	15	30	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	I _D = 5 /	A, V _{DS} = 320 V	-	4	-	nC
Gate-Drain Charge	Q _{gd}				-	7	-	
Turn-On Delay Time	t _{d(on)}				-	12	24	
Rise Time	t _r	Van -	= 400 V, I _D	– 10 Δ	-	18	36	- ns
Turn-Off Delay Time	t _{d(off)}		= 10 V, R _q :		-	18	36	
Fall Time	t _f				-	14	28	1
Gate Input Resistance	R _g	f = 1 MHz, open drain		0.9	1.8	3.6	Ω	
Drain-Source Body Diode Characterist		•				•	•	
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	10		
Pulsed Diode Forward Current	I _{SM}			-	-	40	A	
Diode Forward Voltage	V _{SD}	T _{.J} = 25 °	C, I _S = 5 A	, V _{GS} = 0 V	-	- 1	1.2	V
Reverse Recovery Time	t _{rr}				-	230	-	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 2$	5 °C, I _F = Ig 100 A/µs ^{, V}	$\beta = 5 A,$	-	1.6	-	μC
Reverse Recovery Current	I _{BBM}	dl/dt = 1	100 A/µs ^{, v}	_R = 25 V	-	14	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

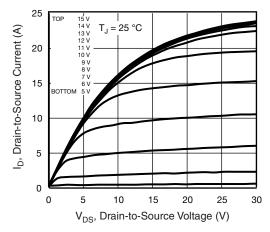


Fig. 1 - Typical Output Characteristics

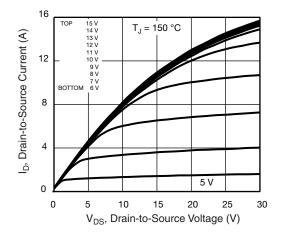


Fig. 2 - Typical Output Characteristics

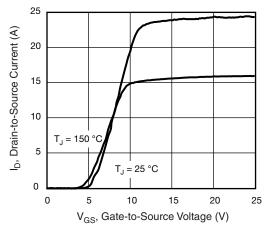


Fig. 3 - Typical Transfer Characteristics

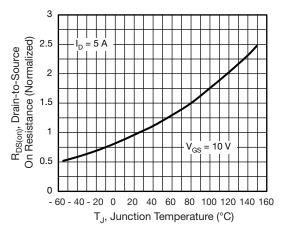


Fig. 4 - Normalized On-Resistance vs. Temperature

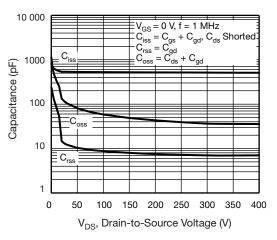
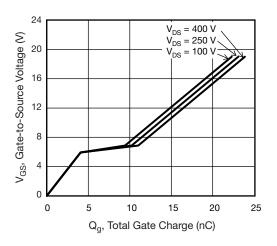


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





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echnical questions, contact; hvm@vishav

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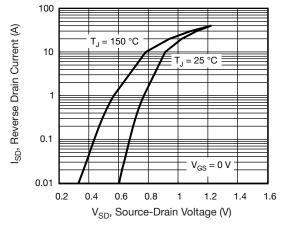


Fig. 7 - Typical Source-Drain Diode Forward Voltage

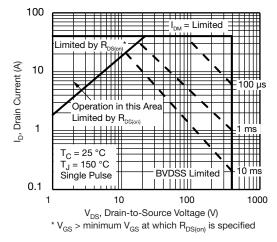


Fig. 8 - Maximum Safe Operating Area

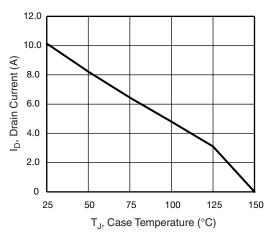


Fig. 9 - Maximum Drain Current vs. Case Temperature

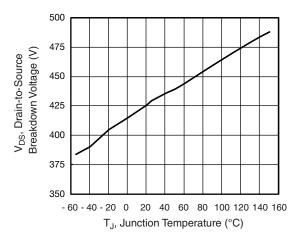
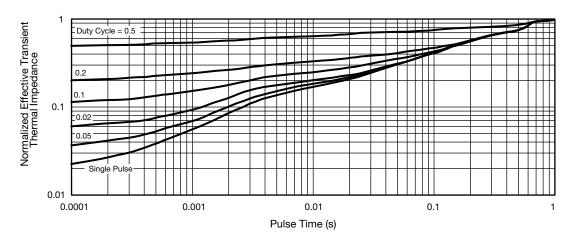


Fig. 10 - Temperature vs. Drain-to-Source Voltage





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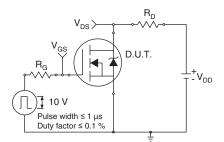


Fig. 12 - Switching Time Test Circuit

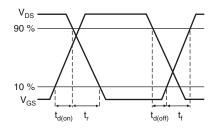


Fig. 13 - Switching Time Waveforms

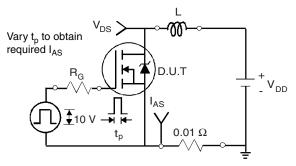


Fig. 14 - Unclamped Inductive Test Circuit

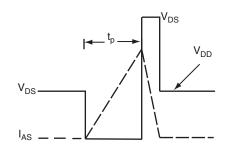


Fig. 15 - Unclamped Inductive Waveforms

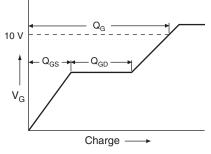


Fig. 16 - Basic Gate Charge Waveform

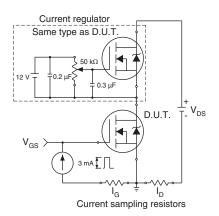


Fig. 17 - Gate Charge Test Circuit

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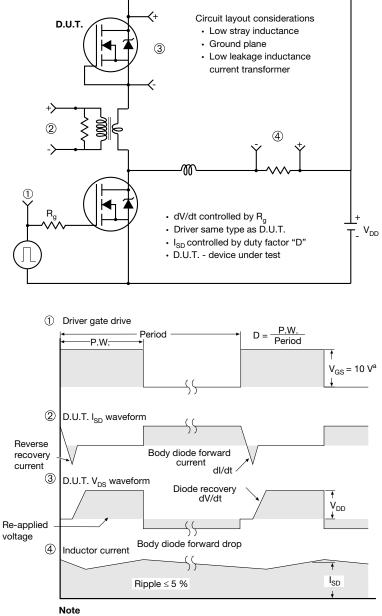
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 18 - For N-Channel

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TO-220 FULLPAK (High Voltage)

OPTION 1: FACILITY CODE = 9



		MILLIMETERS	
DIM.	MIN.	NOM.	MAX.
A	4.60	4.70	4.80
b	0.70	0.80	0.91
b1	1.20	1.30	1.47
b2	1.10	1.20	1.30
С	0.45	0.50	0.63
D	15.80	15.87	15.97
е		2.54 BSC	
E	10.00	10.10	10.30
F	2.44	2.54	2.64
G	6.50	6.70	6.90
L	12.90	13.10	13.30
L1	3.13	3.23	3.33
Q	2.65	2.75	2.85
Q1	3.20	3.30	3.40
ØR	3.08	3.18	3.28

Notes

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
 6. Facility code will be the 1st character located at the 2nd row of the unit marking

1



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OPTION 2: FACILITY CODE = Y



	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54	BSC	0.100) BSC	
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØP	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

DWG: 5972

Notes

1. To be used only for process drawing

2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads

3. All critical dimensions should C meet $C_{pk} > 1.33$

4. All dimensions include burrs and plating thickness

5. No chipping or package damage
6. Facility code will be the 1st character located at the 2nd row of the unit marking

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